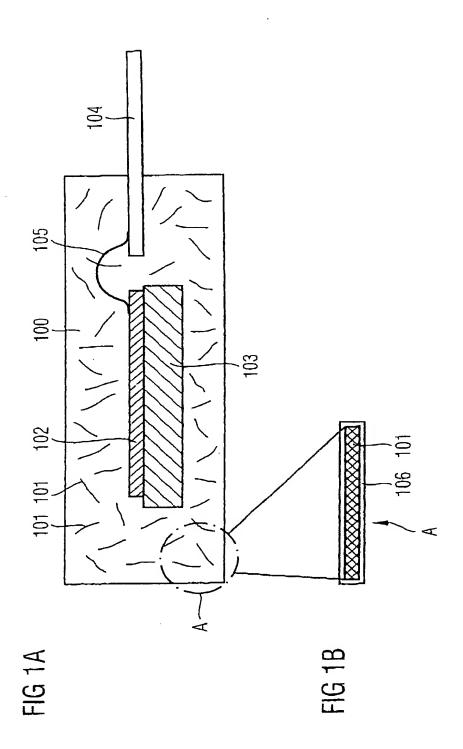
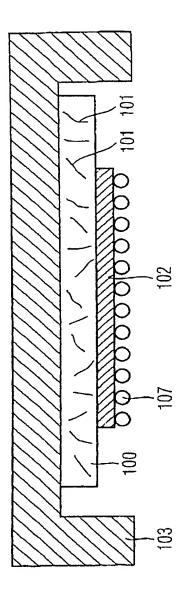
Title: HEAT-CONDUCTING PACKAGING OF ELECTRONIC CIRCUIT UNITS Applicant: Dusberg et al. Atty Docket: 1406/334



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FIG 3 Prior Art

